

# SI3499DV-T1-GE3-VB Datasheet P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
- 60	0.075 at V <sub>GS</sub> = - 10 V	- 6.5	5.1 nC			
	$0.085$ at $V_{GS} = -4.5 \text{ V}$	- 5.5	5.1110			

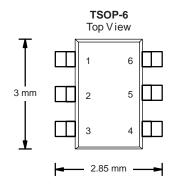
#### **FEATURES**

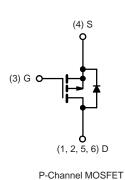
- Halogen-free According to IEC 61249-2-21 Available
- Trench Power MOSFET

# COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

· Load Switch





ABSOLUTE MAXIMUM RATIN	<b>IGS</b> T <sub>A</sub> = 25 °C,	unless other	wise noted		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	$V_{DS}$	- 60	V		
Gate-Source Voltage		$V_{GS}$	± 20	V	
	T <sub>C</sub> = 25 °C		- 6.5		
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C		- 5.2		
Continuous Diam Current (1) = 100 °C)	T <sub>A</sub> = 25 °C	ן טי [	- 6 .1 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	- 5 .3b, c	A	
Pulsed Drain Current		I <sub>DM</sub>	- 19.5		
	T <sub>C</sub> = 25 °C		- 2.5		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	Is	- 1.67 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		3.0		
Maximum Dawar Dissination	T <sub>C</sub> = 70 °C	P <sub>D</sub>	2.0	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	1 'B	2.0 <sup>b, c</sup>	VV	
	T <sub>A</sub> = 70 °C	1 -	1.3 <sup>b, c</sup>		
Operating Junction and Storage Temperatur	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS								
Parameter	Symbol	Typical	Maximum	Unit				
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 5 s	R <sub>thJA</sub>	55	62.5	°C/W			
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	34	41	0,7			

#### Notes:

- a. Based on T<sub>C</sub> = 25 °C.
  b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under Steady State conditions is 110 °C/W.

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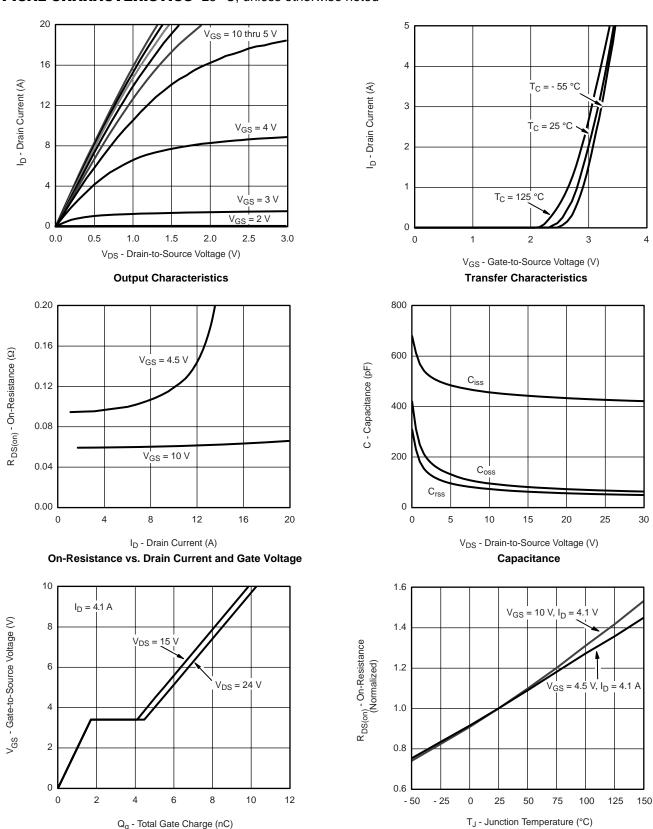


Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 60			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 31		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1 <sub>D</sub> = - 230 μΑ		4.5		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.0		- 3.0	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zara Cata Valtaga Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 48 V, V <sub>GS</sub> = 0 V			- 1	μΑ
Zero Gate Voltage Drain Current		V <sub>DS</sub> = - 48 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 10	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 10			Α
	В	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 2.1 A		0.075		Ω
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -2.1 \text{ A}$		0.085		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 2.1 A		8		S
Dynamic <sup>b</sup>		20 2				
Input Capacitance	C <sub>iss</sub>			1000		
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		80		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			63		
Total Gate Charge	Qg	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 2.1 A		10	15	nC
				5.1	8	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -2.1 \text{ A}$		1.8		
Gate-Drain Charge	$Q_{gd}$			2.5		
Gate Resistance	$R_{g}$	f = 1 MHz		7		Ω
Turn-On Delay Time	t <sub>d(on)</sub>			40	60	ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 4.6 $\Omega$		80	120	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 2.3 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		20	30	
Fall Time	t <sub>f</sub>			12	20	
Turn-On Delay Time	t <sub>d(on)</sub>			5	10	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 4.6 $\Omega$		13	20	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ - 2.3 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		20	30	
Fall Time	t <sub>f</sub>			10	15	
Drain-Source Body Diode Characteristic	cs					
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 6.5	۸
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				- 19.5	A
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 2.3 A		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	-		20	30	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			20	30	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = -2.3 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		14		
Reverse Recovery Rise Time	t <sub>b</sub>			6		ns

- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 % b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

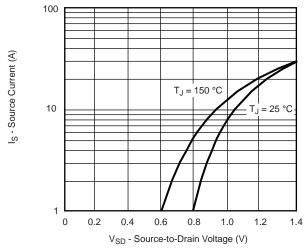


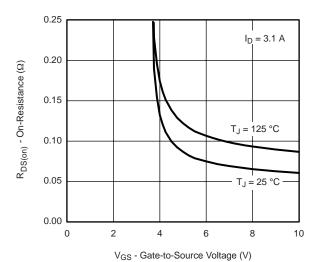


**Gate Charge** 

On-Resistance vs. Junction Temperature

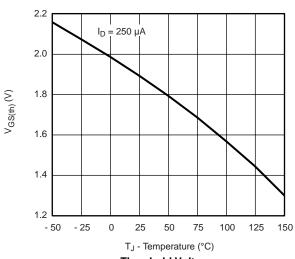


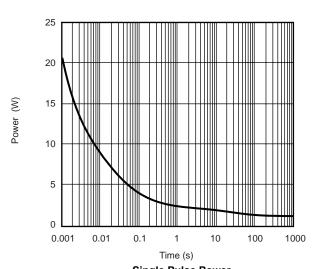




Source-Drain Diode Forward Voltage

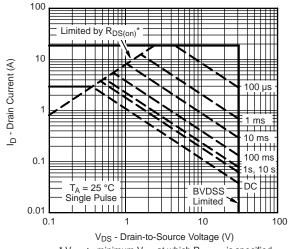






Threshold Voltage

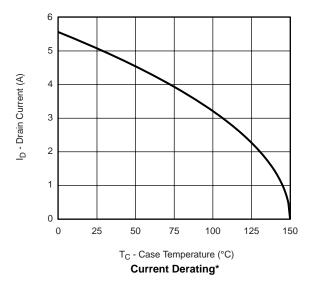
Single Pulse Power

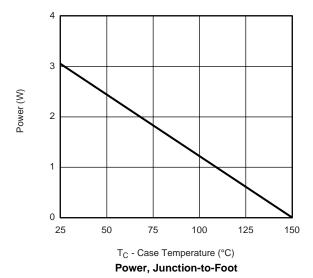


\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area



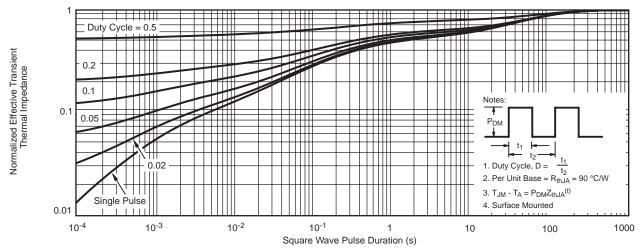




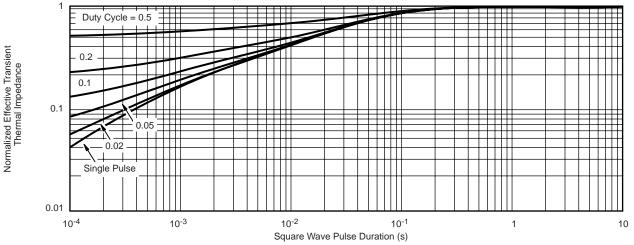
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<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient

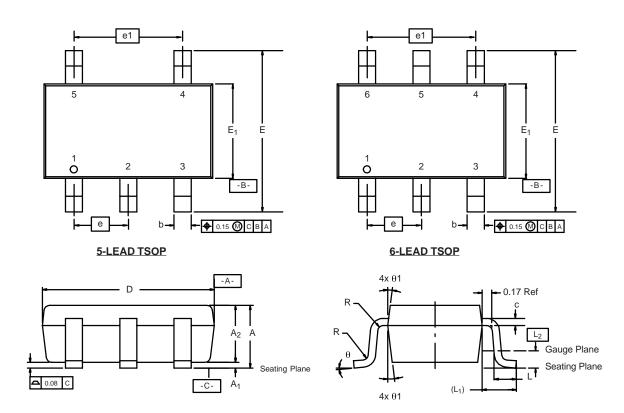


Normalized Thermal Transient Impedance, Junction-to-Foot



TSOP: 5/6-LEAD

**JEDEC Part Number: MO-193C** 

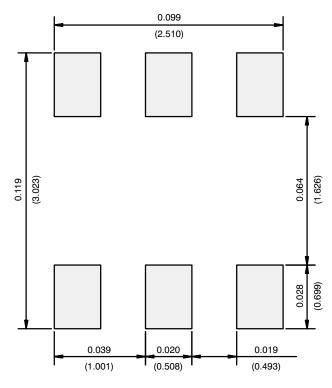


	MILLIMETERS			INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.91	-	1.10	0.036	-	0.043	
A <sub>1</sub>	0.01	-	0.10	0.0004	-	0.004	
A <sub>2</sub>	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
Е	2.70	2.85	2.98	0.106	0.112	0.117	
E <sub>1</sub>	1.55	1.65	1.70	0.061	0.065	0.067	
е	0.95 BSC			0.0374 BSC			
e <sub>1</sub>	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L <sub>1</sub>	0.60 Ref			0.024 Ref			
L <sub>2</sub>	0.25 BSC			0.010 BSC			
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
$\theta_1$	7° Nom			7° Nom			
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540							

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### **RECOMMENDED MINIMUM PADS FOR TSOP-6**



Recommended Minimum Pads Dimensions in Inches/(mm)

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